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AOK53S60

600V 53A α MOS $^{\text{TM}}$ Power Transistor

General Description

The AOK53S60 has been fabricated using the advanced αMOS^{TM} high voltage process that is designed to deliver high levels of performance and robustness in switching applications.

By providing low $R_{DS(on)}$, Q_g and E_{OSS} along with guaranteed avalanche capability this part can be adopted quickly into new and existing offline power supply designs.

Product Summary

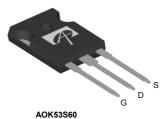
700V V_{DS} @ T_{i,max} 215A I_{DM} $R_{\text{DS}(\text{ON}),\text{max}}$ 0.07Ω 59nC $Q_{g,typ}$ E_{oss} @ 400V 15μJ

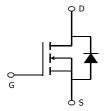
100% UIS Tested 100% R_g Tested











Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOK53S60	TO-247	Tube	240

AOK53S60		10-247	Tube 240	
Absolute Maximum F	Ratings T _A =25°C unles	s otherwise noted		
Parameter		Symbol	AOK53S60	Units
Drain-Source Voltage		V _{DS}	600	V
Gate-Source Voltage		V_{GS}	±30	V
Continuous Drain Current	T _C =25°C		53	
	T _C =100°C	I _D	33	A
Pulsed Drain Current ^C		I _{DM}	215	
Avalanche Current ^C		I _{AR}	9.5	А
Repetitive avalanche energy ^C		E _{AR}	45	mJ
Single pulsed avalanche energy ^G		E _{AS}	1688	mJ
	T _C =25°C	P _D	520	W
Power Dissipation ^B	Derate above 25°C	' D	4.2	W/°C
MOSFET dv/dt ruggedness		dv/dt	100	V/ns
Peak diode recovery dv/dt		aviat	20	V/113
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C
Maximum lead tempe	rature for soldering			
purpose, 1/8" from case for 5 seconds J		TL	300	°C
Thermal Characteris	tics			•
Parameter		Symbol	AOK53S60	Units
Maximum Junction-to-Ambient A,D		$R_{\theta JA}$	40	°C/W
Maximum Case-to-sink ^A		R _{ecs}	0.5	°C/W
Maximum Junction-to-Case		$R_{\theta JC}$	0.24	°C/W



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Dunin Course Dunaledous Valtage	$I_D=250\mu A, V_{GS}=0V, T_J=25^{\circ}C$	600	-	-	
	Drain-Source Breakdown Voltage	I_D =250 μ A, V_{GS} =0V, T_J =150°C	650	700	-	V
I _{DSS}	Zara Cata Valtara Drain Current	V _{DS} =600V, V _{GS} =0V	-	-	1	^
	Zero Gate Voltage Drain Current	V _{DS} =480V, T _J =150°C	-	10	-	μΑ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±30V	-	-	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =5V,I _D =250μA	2.5	3.2	3.8	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =26.5A, T _J =25°C	-	0.058	0.07	Ω
	Static Dialii-Source Oil-Resistance	V _{GS} =10V, I _D =26.5A, T _J =150°C	-	0.155	0.185	Ω
V_{SD}	Diode Forward Voltage	I _S =26.5A,V _{GS} =0V, T _J =25°C	-	0.84	-	V
Is	Maximum Body-Diode Continuous Current			-	53	Α
I _{SM}	Maximum Body-Diode Pulsed Current			-	215	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	3034	-	pF
Coss	Output Capacitance	V _{GS} -0V, V _{DS} -100V, 1-11/1112	-	222	-	pF
C _{o(er)}	Effective output capacitance, energy related H	VGS=0V, V _{DS} =0 to 480V, f=1MHz	-	170	-	pF
C _{o(tr)}	Effective output capacitance, time related ¹	VGS-0V, V _{DS} -0 to 400V, 1-11VII12	-	524	-	pF
C _{rss}	Reverse Transfer Capacitance	VGS=0V, V _{DS} =100V, f=1MHz	-	3	-	pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	1.8	-	Ω
SWITCHI	NG PARAMETERS			•		
Q_g	Total Gate Charge		-	59	-	nC
Q_{gs}	Gate Source Charge	V _{GS} =10V, V _{DS} =480V, I _D =26.5A	-	17	-	nC
Q_{gd}	Gate Drain Charge		-	19	-	nC
t _{D(on)}	Turn-On DelayTime		-	48	-	ns
t _r	Turn-On Rise Time	V _{GS} =10V, V _{DS} =400V, I _D =26.5A,	-	102	-	ns
t _{D(off)}	Turn-Off DelayTime	$R_G=25\Omega$	-	215	-	ns
t _f	Turn-Off Fall Time]	-	122	-	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =26.5A,dI/dt=100A/μs,V _{DS} =400V	-	664	-	ns
I _m	Peak Reverse Recovery Current	I _F =26.5A,dI/dt=100A/μs,V _{DS} =400V	-	36	-	Α
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =26.5A,dI/dt=100A/μs,V _{DS} =400V	-	14	-	μC

- A. The value of R $_{\theta JA}$ is measured with the device in a still air environment with T $_A$ =25 $^\circ$ C.
- B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C, Ratings are based on low frequency and duty cycles to keep initial T_J =25° C.
- D. The R $_{\theta JA}$ is the sum of the thermal impedance from junction to case R $_{\theta JC}$ and case to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.
- G. L=60mH, I_{AS} =7.5A, V_{DD} =150V, Starting T_J =25° C
- H. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.

 I. $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.

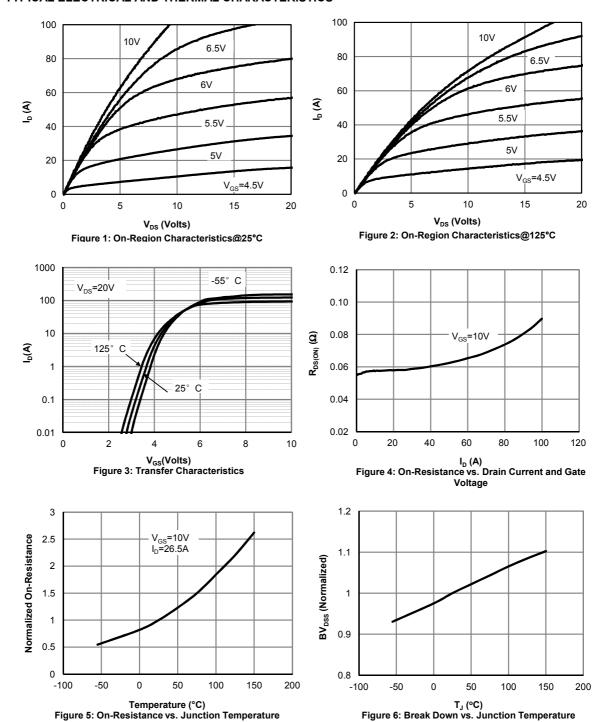
 J. Wavesoldering only allowed at leads.

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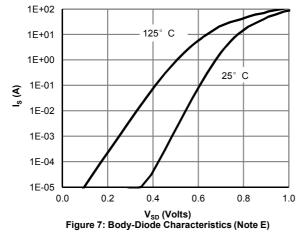
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

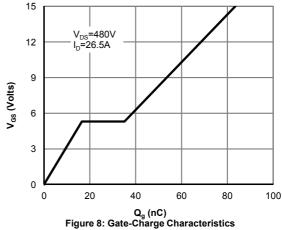
Temperature (°C) Figure 5: On-Resistance vs. Junction Temperature

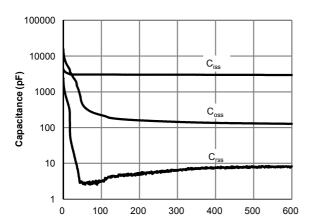


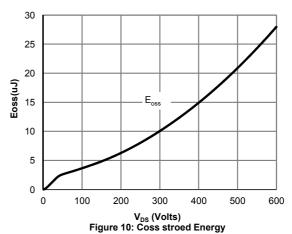


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS











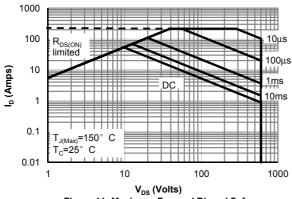
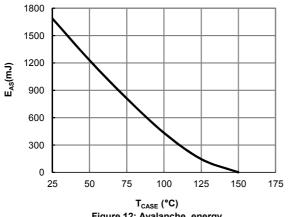


Figure 11: Maximum Forward Biased Safe Operating Area for AOK53S60 (Note F)



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Current rating I_D(A) T_{CASE} (°C)

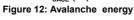
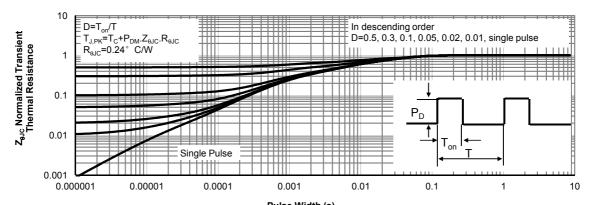


Figure 13: Current De-rating (Note B)

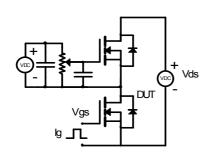


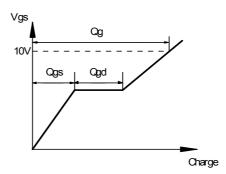
Pulse Width (s)
Figure 14: Normalized Maximum Transient Thermal Impedance for AOK53S60 (Note F)

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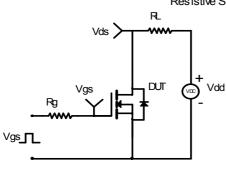


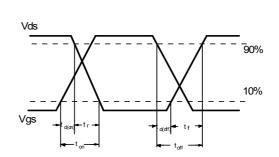
Gate Charge Test Circuit & Waveform



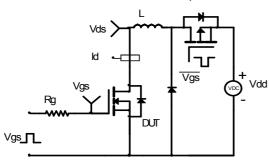


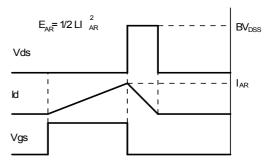
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





 ${\sf Diode\ Recovery\ Test\ Circuit\ \&\ Waveforms}$

